

80C286/883

High Performance Microprocessor with Memory Management and Protection

FN2948
Rev.1.00
March 1997

Features

- **This Circuit is Processed in Accordance to MIL-STD-883 and is Fully Conformant Under the Provisions of Paragraph 1.2.1.**
- **Compatible with NMOS 80286/883**
- **Static CMOS Design for Low Power Operation**
 - ICCSB = 5mA Maximum
 - ICCOP = 185mA Maximum (80C286-10/883)
 - ICCOP = 220mA Maximum (80C286-12/883)
- **Large Address Space**
 - 16 Megabytes Physical
 - 1 Gigabyte Virtual per Task
- **Integrated Memory Management, Four-Level Memory Protection and Support for Virtual Memory and Operating Systems**
- **Two 80C86 Upward Compatible Operating Modes**
 - 80C286/883 Real Address Mode
 - Protected Virtual Address Mode
- **Compatible with 80287 Numeric Data Co-Processor**

Description

The Intersil 80C286/883 is a static CMOS version of the NMOS 80286 microprocessor. The 80C286/883 is an advanced, high-performance microprocessor with specially optimized capabilities for multiple user and multi-tasking systems. The 80C286/883 has built-in memory protection that supports operating system and task isolation as well as program and data privacy within tasks. The 80C286/883 includes memory management capabilities that map 230 (one gigabyte) of virtual address space per task into 2^{24} bytes (16 megabytes) of physical memory.

The 80C286/883 is upwardly compatible with 80C86 and 80C88 software (the 80C286/883 instruction set is a superset of the 80C86/80C88 instruction set). Using the 80C286/883 real address mode, the 80C286/883 is object code compatible with existing 80C86 and 80C88 software. In protected virtual address mode, the 80C286/883 is source code compatible with 80C86 and 80C88 software but may require upgrading to use virtual address as supported by the 80C286/883's integrated memory management and protection mechanism. Both modes operate at full 80C286/883 performance and execute a superset of the 80C86 and 80C88 instructions.

The 80C286/883 provides special operations to support the efficient implementation and execution of operating systems. For example, one instruction can end execution of one task, save its state, switch to a new task, load its state, and start execution of the new task. The segment-not-present exception and restartable instructions.

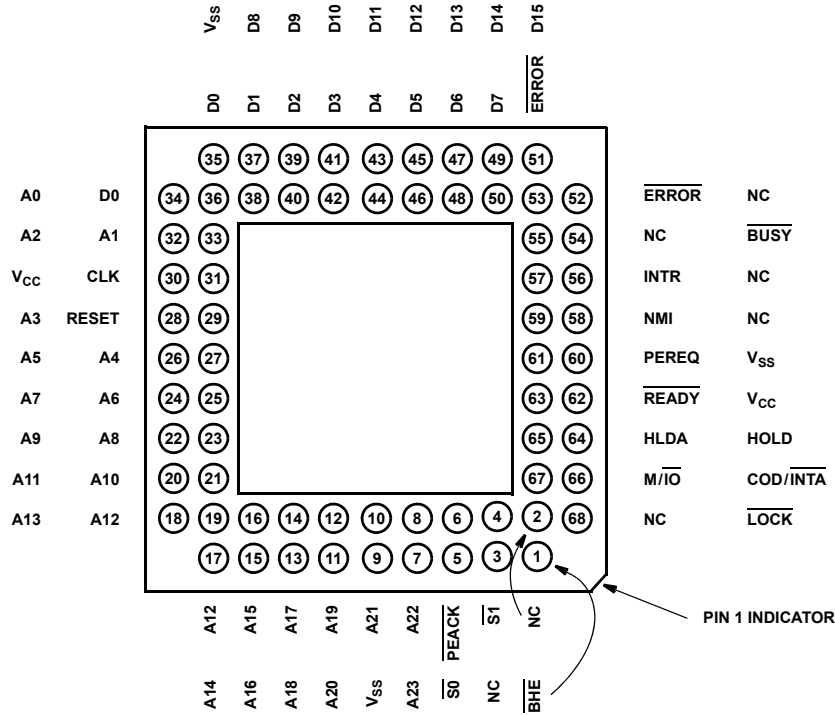
Ordering Information

PACKAGE	TEMP. RANGE	10MHz	12.5MHz	16MHz	20MHz	25MHz	PKG. NO.
68 Pin PGA	0°C to +70°C	-	CG80C286-12	CG80C286-16	CG80C286-20	-	G68.B
	-40°C to +85°C	IG80C286-10	IG80C286-12	-	-	-	G68.B
	-55°C to +125°C	MG80C286-10/883	MG80C286-12/883	-	-	-	G68.B
		5962-9067801MXC	5962-9067802MXC	-	-	-	G68.B

Pinout

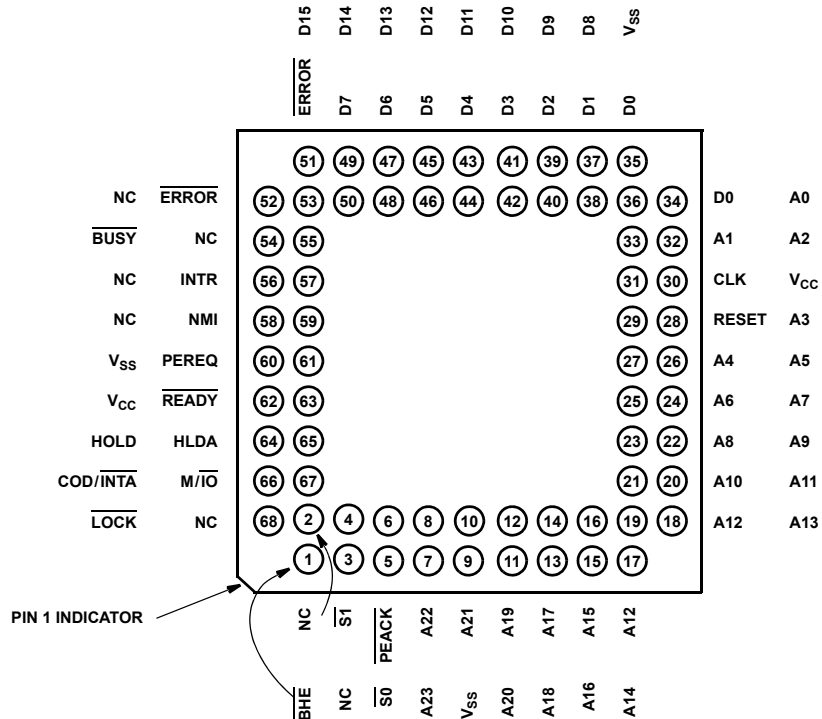
68 LEAD PGA, COMPONENT PAD VIEW

As viewed from underside of the component when mounted on the board.



P.C. BOARD VIEW

As viewed from the component side of the P.C. board.



Absolute Maximum Ratings

Supply Voltage +8.0V
 Input, Output or I/O Voltage Applied GND -1.0V to $V_{CC} + 1.0V$
 Storage Temperature Range -65°C to +150°C
 Junction Temperature +175°C
 Lead Temperature (Soldering 10s) +300°C
 ESD Classification Class 1

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Thermal Information

Thermal Resistance (Typical)
 PGA Package θ_{JA} 35°C/W θ_{JC} 6°C/W
 Gate Count 22,500 Gates

Operating Conditions

Operating Voltage Range +4.5V to +5.5V
 Operating Temperature Range -55°C to +125°C
 System Clock (CLK) RISE Time (From 1.0V to 3.6V) 8ns (Max)
 System Clock (CLK) FALL Time (from 3.6V to 1.0V) 8ns (Max)

Input RISE and FALL Time (From 0.8V to 2.0V)
 80C286-10/883 10ns (Max)
 80C286-12/883 8ns (Max)

TABLE 1. 80C286/883 D.C. ELECTRICAL PERFORMANCE SPECIFICATIONS

Device Guaranteed and 100% Tested

PARAMETER	SYMBOL	CONDITIONS	GROUP A SUB- GROUPS	TEMPERATURE	LIMITS		UNITS
					MIN	MAX	
Input LOW Voltage	V_{IL}	$V_{CC} = 4.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-0.5	0.8	V
Input HIGH Voltage	V_{IH}	$V_{CC} = 5.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	2.0	$V_{CC} + 0.5$	V
CLK Input LOW Voltage	V_{ILC}	$V_{CC} = 4.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-0.5	1.0	V
CLK Input HIGH Voltage	V_{IHC}	$V_{CC} = 5.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	3.6	$V_{CC} + 0.5$	V
Output LOW Voltage	V_{OL}	$I_{OL} = 2.0mA, V_{CC} = 4.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-	0.4	V
Output HIGH Voltage	V_{OH}	$I_{OH} = -2.0mA, V_{CC} = 4.5V$	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	3.0	-	V
		$I_{OH} = -100\mu A, V_{CC} = 4.5V$			$V_{CC} - 0.4$	-	V
Input Leakage Current	I_I	$V_{IN} = GND$ or V_{CC} , $V_{CC} = 5.5V$, Pins 29, 31, 57, 59, 61, 63- 64	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-10	10	μA
Input Sustaining Current LOW	I_{BHL}	$V_{CC} = 4.5V$ and $5.5V$, $V_{IN} = 1.0V$, Note 1	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	38	200	μA
Input Sustaining Current HIGH	I_{BHH}	$V_{CC} = 4.5V$ and $5.5V$, $V_{IN} = 3.0V$, Note 2	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-50	-400	μA
Input Sustaining Current on BUSY and ERROR Pins	I_{SH}	$V_{CC} = 4.5V$ and $5.5V$ $V_{IN} = GND$, Note 5	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-30	-500	μA
Output Leakage Current	I_O	$V_O = GND$ or V_{CC} $V_{CC} = 5.5V$, Pins 1, 7-8, 10-28, 32-34	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-10	10	μA
Active Power Supply Cur- rent	I_{CCOP}	80C286-10/883, Note 4	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-	185	mA
		80C286-12/883, Note 4			-	220	mA
Standby Power Supply Current	I_{CCSB}	$V_{CC} = 5.5V$, Note 3	1, 2, 3	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	-	5	mA

NOTES:

- I_{BHL} should be measured after lowering V_{IN} to GND and then raising to 1.0V on the following pins: 36-51, 66, 67.
- I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering to 3.0V on the following pins: 4-6, 36-51, 66-68.
- I_{CCSB} should be tested with the clock stopped in phase two of the processor clock cycle. $V_{IN} = V_{CC}$ or GND, $V_{CC} = 5.5V$, outputs unloaded.
- I_{CCOP} measured at 10MHz for the 80C286-10/883 and 12.5MHz for the 80C286-12/883. $V_{IN} = 2.4V$ or 0.4V, $V_{CC} = 5.5V$, outputs unloaded.
- I_{SH} should be measured after raising V_{IN} to V_{CC} and then lowering to 0V on pins 53 and 54.

TABLE 2. 80C286/883 AC ELECTRICAL PERFORMANCE SPECIFICATIONS

AC Timings are Referenced to 0.8V and 2.0V Points of the Signals as Illustrated in Datasheet Waveforms, Unless Otherwise Noted. Device Guaranteed and 100% Tested.

PARAMETER	SYMBOL	CONDITIONS	GROUP A SUBGROUPS	TEMPERATURE	80C286/883				UNITS
					10MHz		12.5MHz		
					MIN	MAX	MIN	MAX	
System Clock (CLK) Period	1	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	50	-	40	-	ns
System Clock (CLK) Low Time	2	$V_{CC} = 4.5V$ and $5.5V$ at $1.0V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	12	-	11	-	ns
System Clock (CLK) High Time	3	$V_{CC} = 4.5V$ and $5.5V$ at $3.6V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	16	-	13	-	ns
Asynchronous Inputs SETUP Time (Note 1)	4	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	20	-	15	-	ns
Asynchronous Inputs HOLD Time (Note 1)	5	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	20	-	15	-	ns
RESET SETUP Time	6	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	19	-	10	-	ns
RESET HOLD Time	7	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	0	-	0	-	ns
Read Data SETUP Time	8	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	8	-	5	-	ns
Read Data HOLD Time	9	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	4	-	4	-	ns
\overline{READY} SETUP Time	10	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	26	-	20	-	ns
\overline{READY} HOLD Time	11	$V_{CC} = 4.5V$ and $5.5V$	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	25	-	20	-	ns
Status/ \overline{PEACK} Active Delay, (Note 4)	12A	$V_{CC} = 4.5V$ and $5.5V$, $C_L = 100pF$ $I_L = 2mA $	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	1	22	1	21	ns
Status/ \overline{PEACK} Inactive Delay (Note 3)	12B	$V_{CC} = 4.5V$ and $5.5V$, $C_L = 100pF$ $I_L = 2mA $	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	1	30	1	24	ns
Address Valid Delay (Note 2)	13	$V_{CC} = 4.5V$ and $5.5V$, $C_L = 100pF$ $I_L = 2mA $	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	1	35	1	32	ns
Write Data Valid Delay, (Note 2)	14	$V_{CC} = 4.5V$ and $5.5V$, $C_L = 100pF$ $I_L = 2mA $	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	0	40	0	31	ns
HLDA Valid Delay (Note 5)	15	$V_{CC} = 4.5V$ and $5.5V$, $C_L = 100pF$ $I_L = 2mA $	9, 10, 11	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	0	47	0	25	ns

TABLE 2. 80C286/883 AC ELECTRICAL PERFORMANCE SPECIFICATIONS (Continued)

AC Timings are Referenced to 0.8V and 2.0V Points of the Signals as Illustrated in Datasheet Waveforms, Unless Otherwise Noted. Device Guaranteed and 100% Tested.

PARAMETER	SYMBOL	CONDITIONS	GROUP A SUBGROUPS	TEMPERATURE	80C286/883				UNITS
					10MHz		12.5MHz		
					MIN	MAX	MIN	MAX	

NOTES:

- Asynchronous inputs are INTR, NMI, HOLD, PEREQ, ERROR, and BUSY. This specification is given only for testing purposes, to assure recognition at a specific CLK edge.
- Delay from 1.0V on the CLK to 0.8V or 2.0V.
- Delay from 1.0V on the CLK to 0.8V for Min (HOLD time) and to 2.0V for Max (inactive delay).
- Delay from 1.0V on the CLK to 2.0V for Min (HOLD time) and to 0.8V for Max (active delay).
- Delay from 1.0V on the CLK to 2.0V.

TABLE 3. 80C286/883 ELECTRICAL PERFORMANCE SPECIFICATIONS

PARAMETER	SYMBOL	CONDITIONS	NOTES	TEMPERATURE	80C286/883				UNITS
					10MHz		12.5MHz		
					MIN	MAX	MIN	MAX	
CLK Input Capacitance	C _{CLK}	FREQ = 1MHz	5	T _A = +25°C	-	10	-	10	pF
Other Input Capacitance	C _{IN}	FREQ = 1MH	5	T _A = +25°C	-	10	-	10	pF
I/O Capacitance	C _{I/O}	FREQ = 1MH	5	T _A = +25°C	-	10	-	10	pF
Address/Status/Data Float Delay	15		1, 3, 4, 5	-55°C ≤ T _A ≤ +125°C	0	47	0	32	ns
Address Valid to Status SETUP Time	19	I _L = 2.0mA	1, 2, 5	-55°C ≤ T _A ≤ +125°C	27	-	20	-	ns

NOTES:

- Output Load: C_L = 100pF.
- Delay measured from address either reaching 0.8V or 2.0V (valid) to status going active reaching 0.8V or status going inactive reaching 2.0V.
- Delay from 1.0V on the CLK to Float (no current drive) condition.
- I_L = -6mA (V_{OH} to Float), I_L = 8mA (V_{OL} to Float).
- The parameters listed in Table 3 are controlled via design or process parameters and are not directly tested. These parameters are characterized upon initial design and after major process and/or design changes.

TABLE 4. APPLICABLE SUBGROUPS

CONFORMANCE GROUPS	METHOD	SUBGROUPS
Initial Test	100%/5004	-
Interim Test	100%/5004	1, 7, 9
PDA	100%	1
Final Test	100%	2, 3, 8A, 8B, 10, 11
Group A	-	1, 2, 3, 7, 8A, 8B, 9, 10, 11
Group C & D	Samples/5005	1, 7, 9

AC Electrical Specifications 82C284 and 82C288 Timing Specifications Are Given For Reference Only, And No Guarantee is Implied.**82C284 Timing**

SYMBOL	PARAMETER	10MHz		12.5MHz		UNIT	TEST CONDITION
		MIN	MAX	MIN	MAX		
TIMING REQUIREMENTS							
11	$\overline{\text{SRDY}}/\overline{\text{SRDYEN}}$ Setup Time	15	-	15	-	ns	
12	$\overline{\text{SRDY}}/\overline{\text{SRDYEN}}$ Hold Time	2	-	2	-	ns	
13	$\overline{\text{ARDY}}/\overline{\text{ARDYEN}}$ Setup Time	5	-	5	-	ns	(Note 1)
14	$\overline{\text{ARDY}}/\overline{\text{ARDYEN}}$ Hold Time	30	-	25	-	ns	(Note 1)
TIMING RESPONSES							
19	PCLK Delay	0	20	0	16	ns	$C_L = 75\text{pF}$, $I_{OL} = 5\text{mA}$, $I_{OH} = -1\text{mA}$

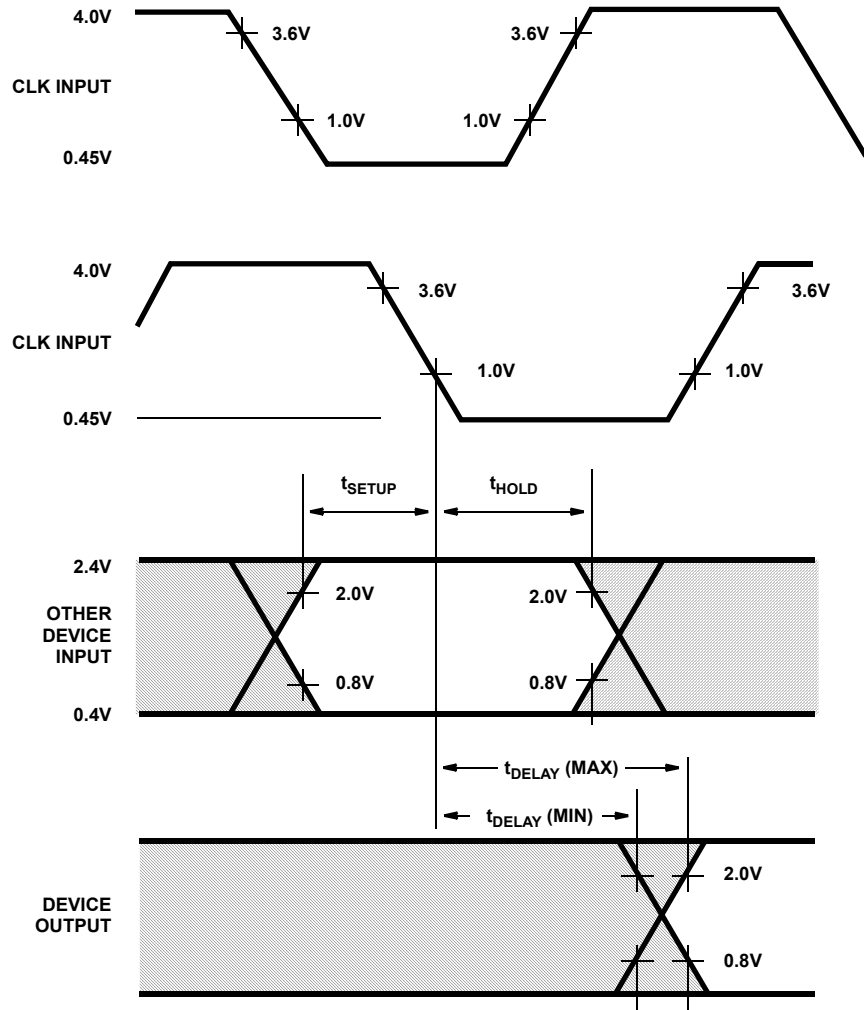
NOTE:

1. These times are given for testing purposes to ensure a predetermined action.

82C288 Timing

SYMBOL	PARAMETER	10MHz		12.5MHz		UNIT	TEST CONDITION
		MIN	MAX	MIN	MAX		
TIMING REQUIREMENTS							
12	CMDLY Setup Time	15	-	15	-	ns	
13	CMDLY Hold Time	1	-	1	-	ns	
TIMING RESPONSES							
16	ALE Active Delay	1	16	1	16	ns	
17	ALE Inactive Delay	-	19	-	19	ns	
19	$\text{DT}/\overline{\text{R}}$ Read Active Delay	-	23	-	23	ns	$C_L = 150\text{pF}$
20	DEN Read Active Delay	0	21	0	21	ns	$I_{OL} = 16\text{mA Max}$
21	DEN Read Inactive Delay	3	23	3	21	ns	$I_{OH} = -1\text{mA Max}$
22	$\text{DT}/\overline{\text{R}}$ Read Inactive Delay	5	24	5	18	ns	
23	DEN Write Active Delay	-	23	-	23	ns	
24	DEN Write Inactive Delay	3	23	3	23	ns	
29	Command Active Delay from CLK	3	21	3	21	ns	$C_L = 300\text{pF}$
30	Command Inactive Delay from CLK	3	20	3	20	ns	$I_{OL} = 32\text{mA Max}$

AC Specifications

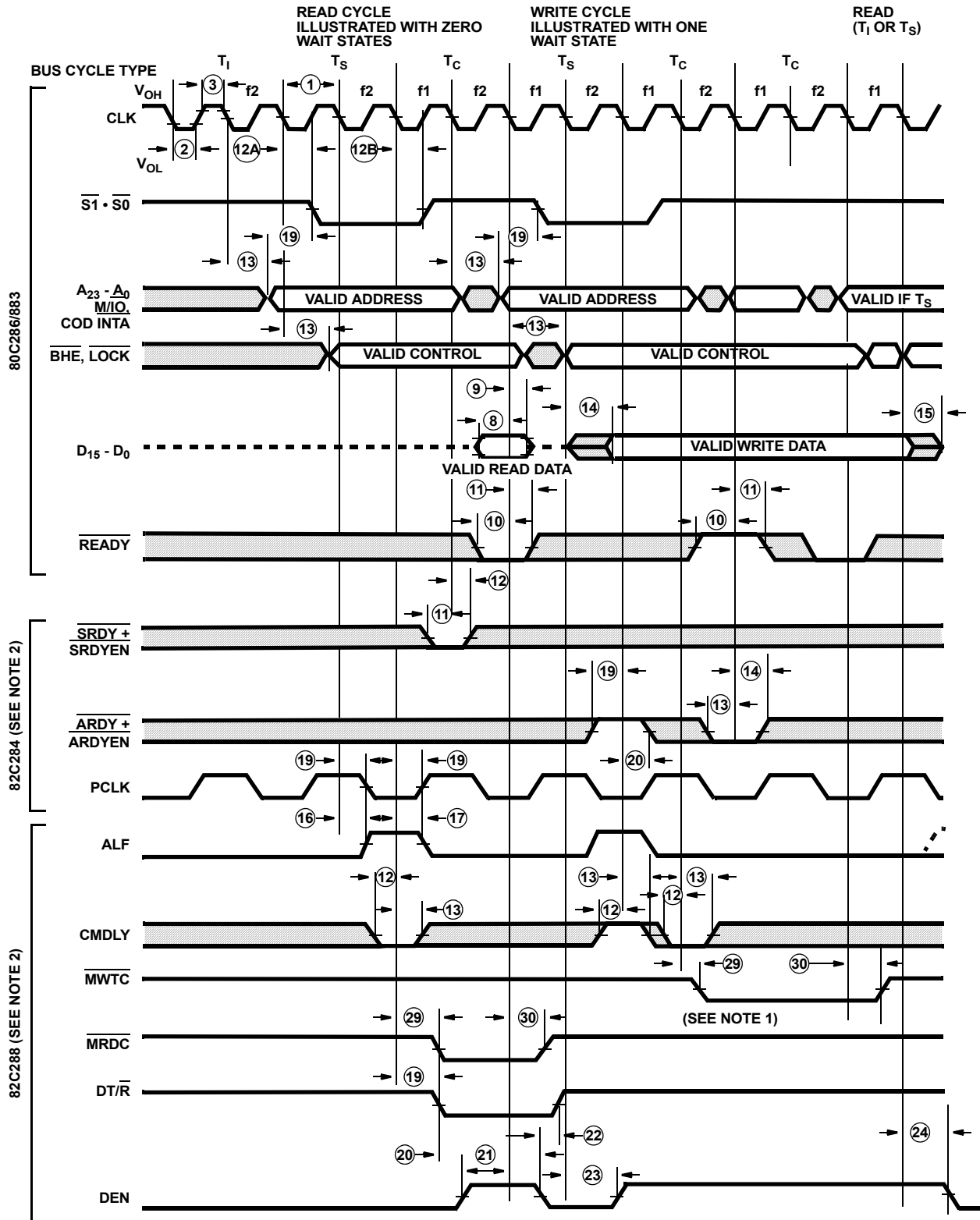


NOTE:

1. For AC testing, input rise and fall times are driven at 1ns per volt.

FIGURE 1. AC DRIVE AND MEASURE POINTS - CLK INPUT

Waveforms

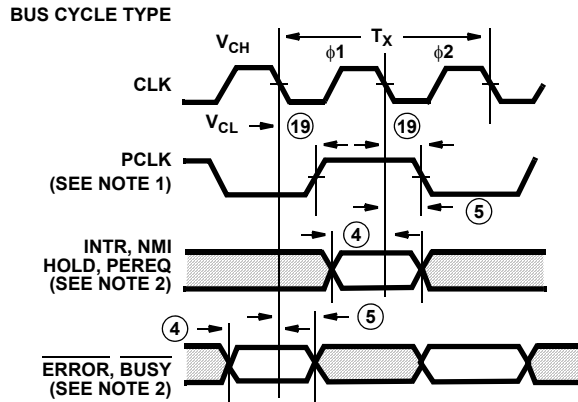


NOTES:

1. The modified timing is due to the CMDLY signal being active.
2. 82C254 and 82C288 Timing Waveforms are shown for reference only, and no guarantee is implied.

FIGURE 2. MAJOR CYCLE TIMING

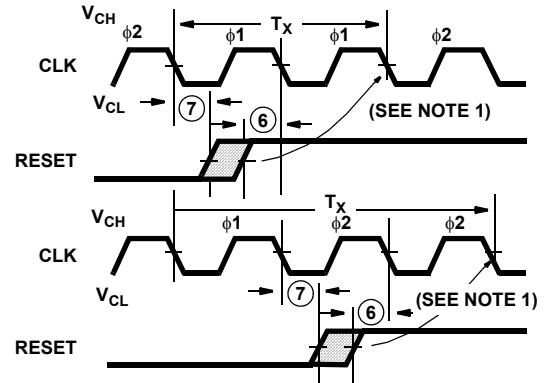
Waveforms (Continued)



NOTES:

1. PCLK indicates which processor cycle phase will occur on the next CLK. PCLK may not indicate the correct phase until the first cycle is performed.
2. These inputs are asynchronous. The setup and hold times shown assure recognition for testing purposes.

FIGURE 3. 80C286/883 ASYNCHRONOUS INPUT SIGNAL TIMING

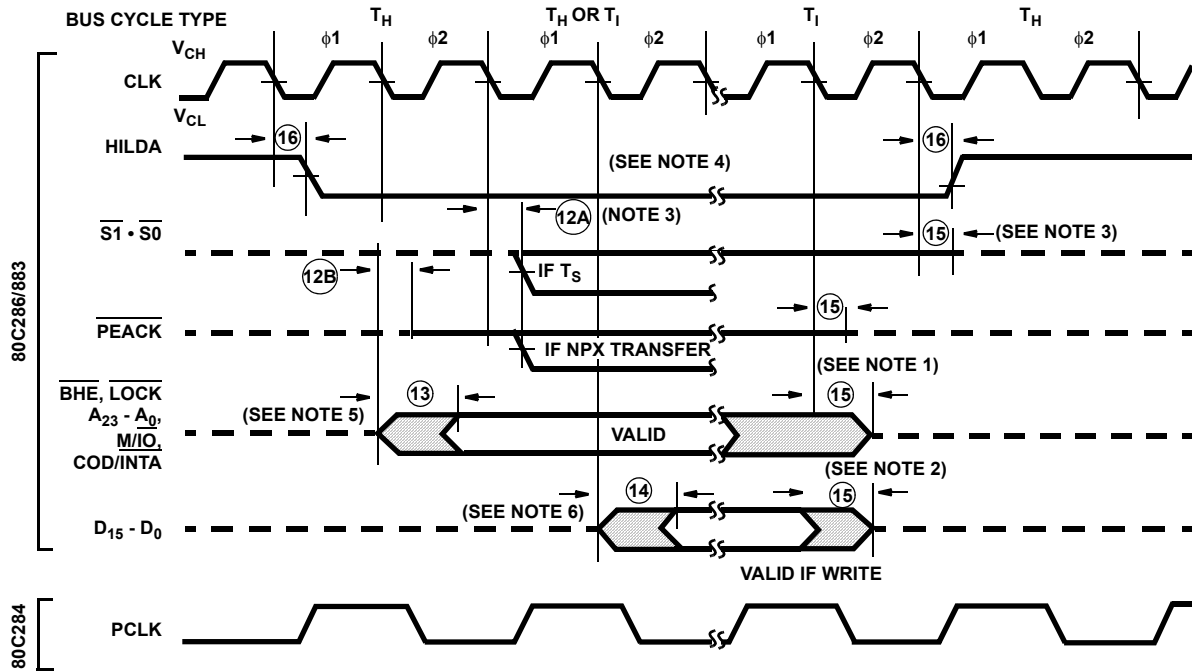


NOTE:

1. When RESET meets the setup time shown, the next CLK will start or repeat $\phi 1$ of a processor cycle.

FIGURE 4. 80C286/883 RESET INPUT TIMING AND SUBSEQUENT PROCESSOR CYCLE PHASE

Waveforms (Continued)



NOTES:

1. These signals may not be driven by the 80C286/883 during the time shown. The worst case in terms of latest float time is shown.
2. The data bus will be driven as shown if the last cycle before T_I in the diagram was a write T_C .
3. The 80C286/883 puts its status pins in a high impedance logic one state during T_H .
4. For HOLD request set up to HLDA, refer to Figure 8.
5. \overline{BHE} and \overline{LOCK} are driven at this time but will not become valid until T_S .
6. The data bus will remain in a high impedance state if a read cycle is performed.

FIGURE 5. EXITING AND ENTERING HOLD

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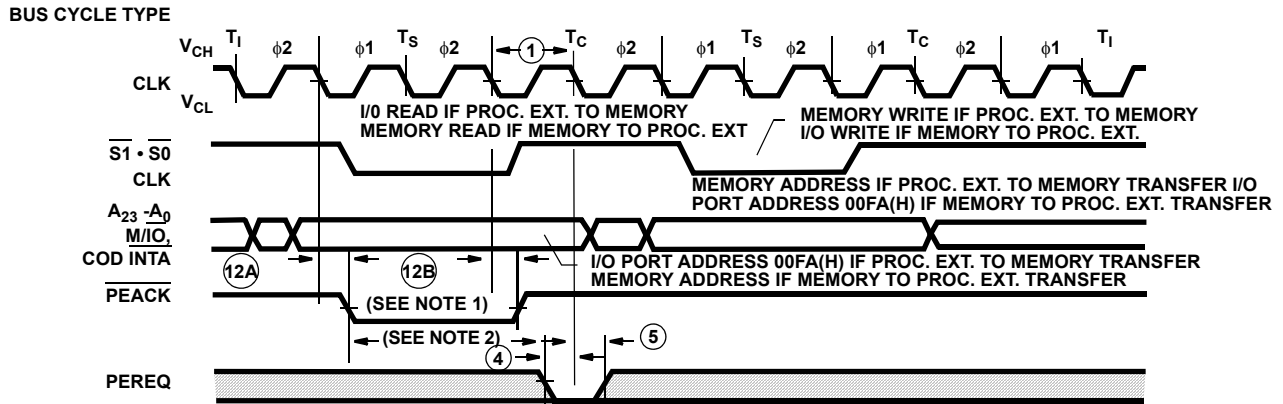
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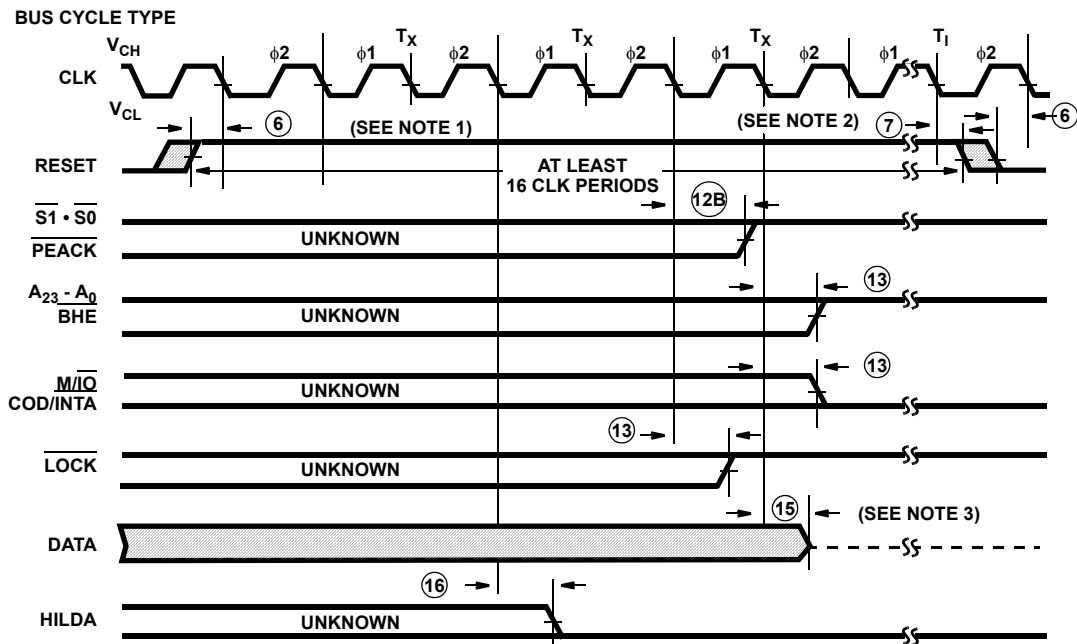
Waveforms (Continued)



NOTES:

1. \overline{PEACK} always goes active during the first bus operation of a processor extension data operand transfer sequence. The first bus operation will be either a memory read at operand address or I/O read at port address 00FA(H).
2. To prevent a second processor extension data operand transfer, the worst case maximum time (shown above) is $3 \times (1) - 12A_{MAX} - (4)_{MIN}$. The actual, configuration dependent, maximum time is: $3 \times (1) - 12A_{MAX} - (4)_{MIN} + N \times 2 \times (1)$. N is the number of extra T_c states added to either the first or second bus operation of the processor extension data operand transfer sequence.

FIGURE 6. 80C286/883 PEREQ/PEACK TIMING FOR ONE TRANSFER ONLY

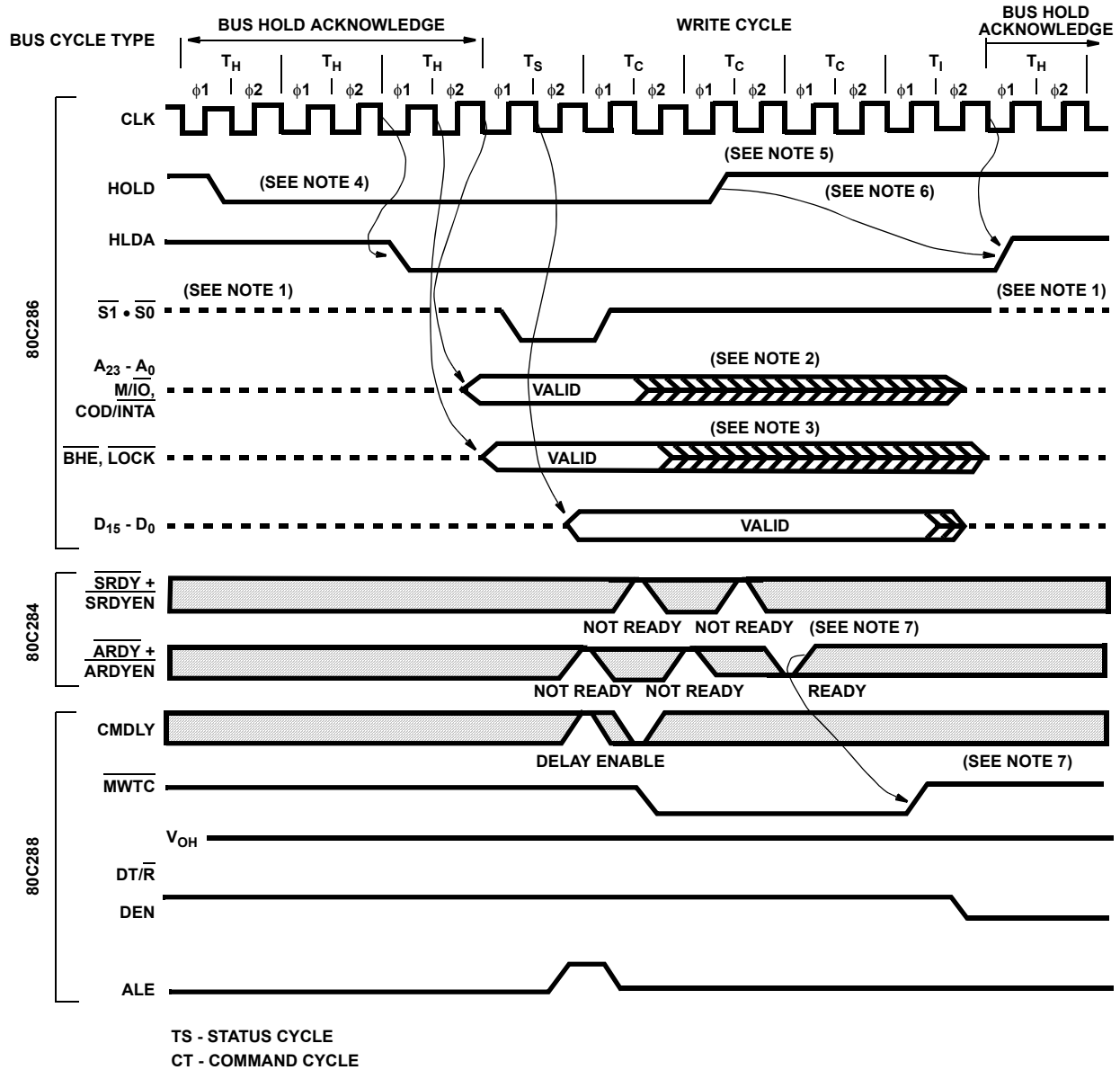


NOTES:

1. Setup time for $\overline{RESET} \uparrow$ may be violated with the consideration that ϕ_1 of the processor clock may begin one system CLK period later.
2. Setup and hold times for $\overline{RESET} \downarrow$ must be met for proper operation, but $\overline{RESET} \downarrow$ may occur during ϕ_1 or ϕ_2 .
3. The data bus is only guaranteed to be in a high impedance state at the time shown.

FIGURE 7. INITIAL 80C286/883 PIN STATE DURING RESET

Waveforms (Continued)

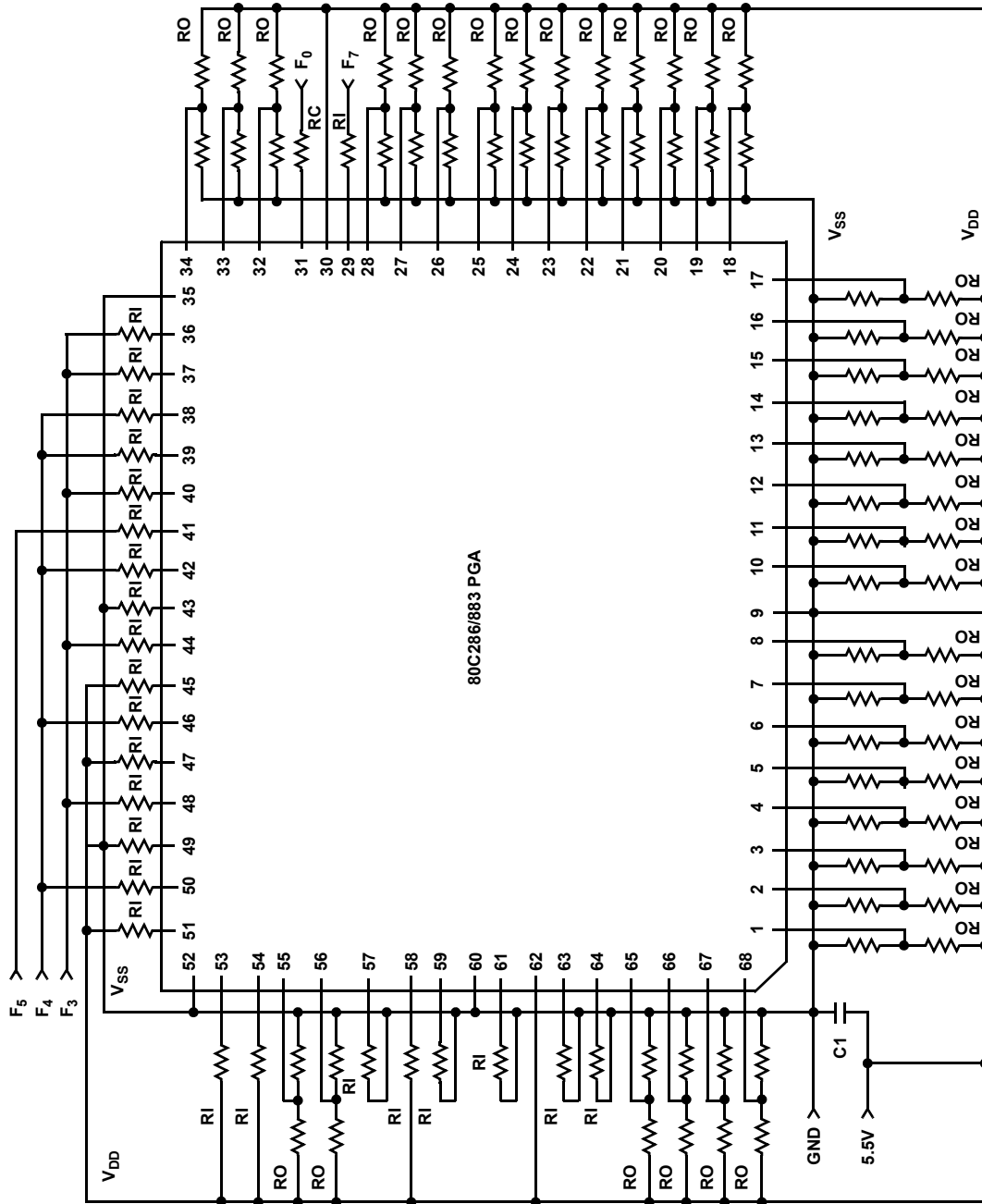


NOTES:

1. Status lines are held at a high impedance logic one by the 80C286 during a HOLD state.
2. Address, $\overline{M/IO}$ and $\overline{COD/INTA}$ may start floating during any T_C depending on when internal 80C286 bus arbiter decides to release bus to external HOLD. The float starts in ϕ_2 of T_C .
3. \overline{BHE} and \overline{LOCK} may start floating after the end of any T_C depending on when internal 80C286 bus arbiter decides to release bus to external HOLD. The float starts in ϕ_1 of T_C .
4. The minimum HOLD to HLDA time is shown. Maximum is one T_H longer.
5. The earliest HOLD time is shown. It will always allow a subsequent memory cycle if pending is shown.
6. The minimum HOLD to HLDA time is shown. Maximum is a function of the instruction, type of bus cycle and other machine state (i.e., Interrupts, Waits, Lock, etc.).
7. Asynchronous ready allows termination of the cycle. Synchronous ready does not signal ready in this example. Synchronous ready state is ignored after ready is signaled via the asynchronous input.

FIGURE 8. MULTIBUS WRITE TERMINATED BY ASYNCHRONOUS READY WITH BUS HOLD

Burn-In Circuit



NOTES:

8. Supply Voltage: $V_{DD} = 5.5V$, $V_{SS} = 0.0V$.
9. Input Voltage Limits: V_{IL} (Maximum) = 0.8V, V_{IH} (Minimum) = 2.0V
10. Component Values: $RC = 1k\Omega \pm 5\%$, $RI = 10k\Omega \pm 5\%$, $RO =$ Two Series $2.7k\Omega \pm 5\%$
11. Capacitor Values: $C1 = 0.1$ Microfarads
12. Oven Type and Frequency Requirements: Wakefield Oven Board $f_0 = 100kHz$, $f_3 = 12.5kHz$, $f_4 = 6.25kHz$, $f_5 = 3.125kHz$, $f_7 = 781.25Hz$.
13. Special Requirements: (a) ELECTROSTATIC DISCHARGE SENSITIVE. Proper Precautions Must be Used When Handling Units. (b) All Power Supplies Must be at Zero Volts When the Boards are Inserted into the Ovens. (c) When Powering Up, the Inputs Must be Held Below the V_{DD} Voltage. (d) If an Excessive Current is Indicated at Final Inspection, Check to See if a Part is Inserted Backwards or is Latched Up.

Die Characteristics

DIE DIMENSIONS:

286 x 283 x 19 ±1mils

METALLIZATION:

Type: Si-Al

Thickness: 8kÅ

GLASSIVATION:

Type: Nitrox

Thickness: 10kÅ

WORST CASE CURRENT DENSITY: $2 \times 10^5 \text{A/cm}^2$

LEAD TEMPERATURE: (10s Soldering): $\leq 300^\circ\text{C}$

Metallization Mask Layout

80C286/883

